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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chun I HSIEH	01/03/2012
Vishwanath BHAT	01/03/2012
Jennifer SIGMAN	12/30/2011
Vassil ANTONOV	12/30/2011
Wei Hui HSU	01/03/2012

RECEIVING PARTY DATA

Name:	NAN YA TECHNOLOGY CORPORATION
Street Address:	Hwa-Ya Technology Park 669, Fuhsing 3 Rd.
City:	Kueishan, Tao-Yuan Hsien
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13348761

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	HSLE-0039
NAME OF SUBMITTER:	Juan Carlos A. Marquez

Total Attachments: 2

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PATENT REEL: 027521 FRAME: 0587 OP \$40.00 13348761

ASSIGNMENT

WHEREAS, Hsieh, Chun I, Vishwanath Bhat, Jennifer Sigman, Vassil Antonov, and Hsu, Wei				
Hui, whose post office address(es) appear below hereinafter referred to as ASSIGNOR, have invented				
certain new and useful improvements in a <u>METHOD FOR FORMING RUTILE TITANIUM</u>				
OXIDE AND THE STACKING STRUCTURE THEREOF (hereinafter referred to as THE				
INVENTION) for which an application for United States Letters Patent was filed on				
Application Number, or is being filed herewith;				

WHEREAS, NAN YA TECHNOLOGY CORPORATION., whose post office address is HWA-YA TECHNOLOGY PARK 669, FUHSING 3 RD., KUEISHAN, TAO-YUAN HSIEN, TAIWAN, R.O.C. (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.

ALSO, ASSIGNOR here by agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

PATENT REEL: 027521 FRAME: 0588

Name: Hsieh, Chun I Address: 7F., No.120, Ln. 1216, Zhongshan Rd., Taoyuan City, Taoyuan County 330, Taiwan (R.O.C.)	Signature 1/3/2012 Date
Name: Vishwanath Bhat Address: 4715 E. Pegasus Ct., Boise, ID 83716, US	Signature 01/03/2012 Date
Name: <u>Jennifer Sigman</u> Address: <u>1929 N 17th St.</u> , Boise ID 83702	Signature 12 30 20 1 Date
Name: Vassil Antonov Address: 3684 Vintage Way, Boise, ID 83706, US	Signature 12/30/2011 Date
Name: Hsu, Wei Hui Address: No.19, Rong'an 11th St., Zhongli City, Taoyuan County 320, Taiwan (R.O.C.)	Signature Usa